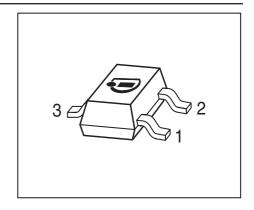


NPN Silicon RF Transistor

- For broadband amplifiers up to 1 GHz at collector currents from 1 mA to 20 mA
- Pb-free (RoHS compliant) package





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package
BFS17P	MCs	1 = B	2 = E	3 = C	SOT23

Maximum Ratings at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{\sf CEO}$	15	V
Collector-base voltage	V_{CBO}	25	
Emitter-base voltage	V_{EBO}	2.5	
Collector current	I _C	25	mA
Peak collector current	I_{CM}	50	
Total power dissipation ¹⁾	P _{tot}	280	mW
_ <i>T</i> _S ≤ 55 °C			
Junction temperature	T_{J}	150	°C
Ambient temperature	T_{A}	-65 150	
Storage temperature	$T_{ m Stg}$	-65 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	≤ 340	K/W

1

 $^{{}^{1}}T_{\mathrm{S}}$ is measured on the collector lead at the soldering point to the pcb

 $^{^2}$ For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V _{(BR)CEO}	15	-	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0	, ,				
Collector-base cutoff current	I _{CBO}				μA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$		-	-	0.05	
$V_{\rm CB} = 25 \text{V}, I_{\rm E} = 0$		-	-	10	
Emitter-base cutoff current	/ _{EBO}	-	-	100	
$V_{\rm EB}$ = 2.5 V, $I_{\rm C}$ = 0					
DC current gain	h _{FE}				-
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 1 V, pulse measured		40	-	150	
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 1 V, pulse measured		20	70	-	
Collector-emitter saturation voltage	V _{CEsat}	-	0.1	0.4	V
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 1 mA					



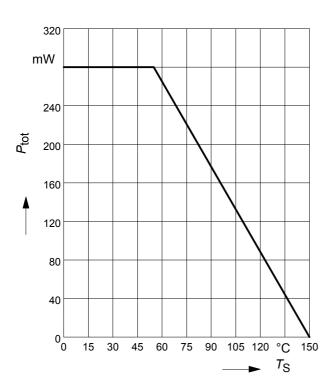
Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

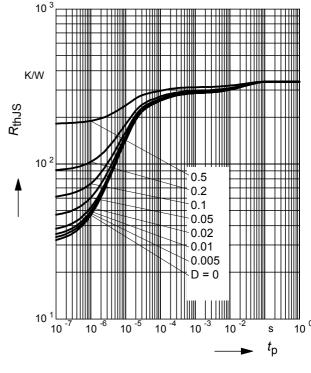
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)				
Transition frequency	f_{T}				GHz
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 5 V, f = 200 MHz		1	1.4	-	
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 5 V, f = 200 MHz		1.3	2.5	-	
Collector-base capacitance	C _{cb}	-	0.55	0.8	pF
$V_{CB} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.27	-	
$V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	0.9	1.45	
$V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$,					
collector grounded					
Minimum noise figure	NF _{min}	-	3.5	5	dB
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 5 V, $Z_{\rm S}$ = 50 Ω ,					
f = 800 MHz					
Transducer gain	S _{21e} ²	-	13	-	dB
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 5 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
f = 500 MHz					
Third order intercept point at output	IP ₃	-	21.5	-	dBm
V_{CE} = 5 V, I_{C} = 20 mA, f = 800 MHz,					
$Z_{S} = Z_{Sopt}, Z_{L} = Z_{Lopt}$					
1dB compression point	P _{-1dB}	-	10	-	-
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 5 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
f = 800 MHz					



Total power dissipation $P_{tot} = f(T_S)$

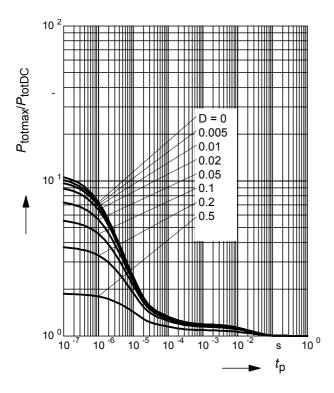
Permissible Pulse Load $R_{thJS} = f(t_p)$



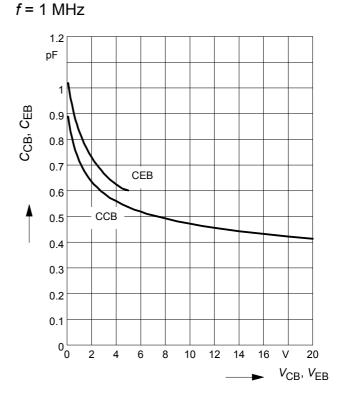


Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$



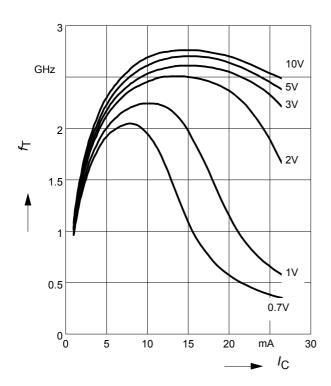
Collector-base capacitance $C_{cb} = f(V_{CB})$ Emitter-base capacitance $C_{eb} = f(V_{EB})$





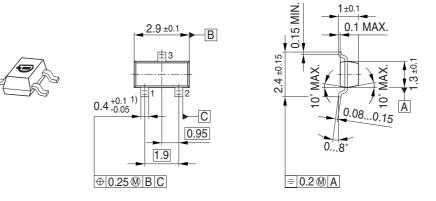
Transition frequency $f_T = f(I_C)$

 V_{CE} = parameter



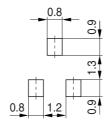


Package Outline

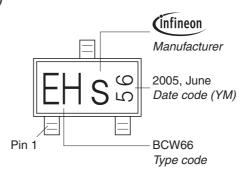


1) Lead width can be 0.6 max. in dambar area

Foot Print

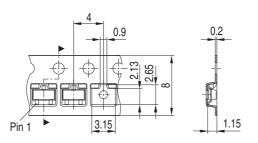


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel



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